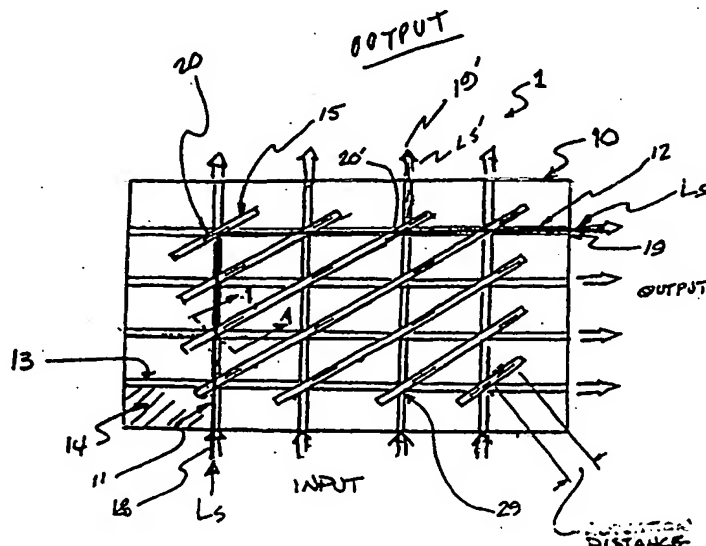




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(54) Title: **FLUID-ENCAPSULATED MEMS OPTICAL SWITCH**

(57) Abstract

A fluid encapsulated MEMS optical switch includes an optical waveguide matrix with MEMS mirrors (22) situated in trenches located at waveguide cross-points (29). The trenches are filled with collimation-maintaining fluid (30) and the mirrors (22) are immersed therein. The collimation maintaining fluid (30) prevents the light beam from spreading when it enters the switch cross-points. This feature enables the use of much smaller MEMS mirrors (22) and prevents some of the typical MEMS mirror (22) problems found in the related art. In particular, the MEMS mirrors (22) disclosed in the present invention is reduced to approximately 15 wide and 2 thick, resulting in shorter actuation distances to approximately 15. This feature results in an optical switch having faster switching times.

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FLUID-ENCAPSULATED MEMS OPTICAL SWITCH

CROSS-REFERENCE TO RELATED APPLICATIONS

This is a continuation-in-part of U.S. Provisional Patent Application Serial No. 60/105,323 filed on October 23, 1998, the content of which is relied upon and incorporated herein by reference in its entirety, and the benefit of priority under 35 U.S.C. § 119(e) is hereby claimed.

FIELD OF THE INVENTION

This invention relates generally to optical switches. In particular, the invention relates to an optical switching array that uses a movable MEMS mirror immersed in an index-matching collimation-maintaining fluid for both an open position and closed position of the switch.

BACKGROUND OF THE INVENTION

The approaches suggested for optical switches can be broadly classified into two categories: the guided wave approach, and the free-space approach. The guided-wave approach includes multilayer waveguides with bending modulation and specialty-material-based switching, whereas the free-space approach generally relies on movable optical elements such as mirrors or lenses.

Mach-Zehnder Interferometer devices, Y-branch waveguides, and other devices are commonly used in the guided-wave approach. Light is diverted from one arm of the

device into the other by changing the refractive index of one of the arms of the device. This is typically done using electrical, thermal, or some other actuating mechanism.

The free-space approach has an advantage over the guided-wave approach in some applications. It has very low cross talk because the waveguides are physically isolated
5 from one another and coupling cannot occur. The only source of cross talk in this approach is due to scattering off the movable optical element. In addition, free-space devices are wavelength-independent and often temperature-independent.

There have been several free-space approaches that have been proposed. One such approach uses a switch array with movable micro-electro-mechanical system (MEMS)
10 mirrors. The input and output optical fibers are set in grooves and are disposed orthogonal to each other. The MEMS mirrors are positioned at the intersection of the input fibers and the output fibers, in free space. This method requires fairly large mirrors and collimators. This is due to the inevitable spreading of the light beam as it leaves the waveguide and travels in free-space toward the MEMS mirror. The large
15 mirrors are problematic because of their requirements for angular placement accuracy, flatness, and the difficulty of actuating such a relatively large structure quickly and accurately. These devices typically have an actuation distance of 300 μ m to 400 μ m, which negatively impacts switching speed. In addition, the individual collimators must be assembled for each input and output fiber, thus increasing fabrication costs.

In a second free-space approach, a planar waveguide array is used. Trenches are
20 formed at the cross-points of the input waveguides and the output waveguides. Digital micromirror devices (DMD) are positioned within the trenches, in free-space. Each micromirror acts like a shutter and is rotated into the closed position by an electrostatic or a magnetic actuator so that the light signal is reflected from an input waveguide into
25 an output waveguide. When the shutter is in the open position, the light continues to propagate in the original direction without being switched. This method is also subject to the beam-spreading problem, and it appears that the typical losses from such a switch would be high.

A third free-space approach uses an index-matching fluid as the switching element.
30 A planar waveguide array is formed on a substrate. Trenches are formed at the cross-points and are filled with a fluid that matches the refractive index of the waveguide core. In order to actuate the switch, the fluid is either physically moved in and out of

the cross-point using an actuator, or the fluid is thermally or electrolytically converted into a gas to create a bubble. For this approach to work, the facets cut at the end of the waveguide at the cross-points must be of mirror quality, since they are used to reflect the light into the desired waveguide. Finally, the fluid must be withdrawn cleanly to preserve the desired facet geometry and to prevent scattering losses due to any remaining droplets.

In yet another approach, a beam is disposed diagonally over a gap in a waveguide. A mirror is suspended from the beam into the gap. An electrode is disposed adjacent to the gap and underneath the beam. When the electrode is addressed, the beam and mirror move into the gap to reflect light propagating in the waveguide. This approach has several disadvantages. This method is also subject to the beam-spreading problem discussed above. Again, it appears that the typical losses from such a switch would be high. Second, the electrodes are disposed on the substrate that the waveguides are disposed in. This design is costly to reproduce.

Thus, a need exists for an optical switch having the advantages of the free-space approach, without the disadvantages of the related designs discussed above.

SUMMARY OF THE INVENTION

The present invention addresses the needs discussed above. A movable MEMS mirror is disposed in a trench that is filled with a non-conducting, low-viscosity, index-matching fluid. The index-matching fluid functions as a collimation-maintaining fluid that prevents the light beam from spreading in switch cross-points. Thus, smaller mirrors are used at switch cross-points resulting in smaller actuation distances, and shorter actuation times.

One aspect of the present invention is an optical switch for directing a light signal. The optical switch includes at least one optical waveguide having an input port, an output port, and a core portion having a refractive index n_1 . The switch also includes at least one trench formed in the at least one optical waveguide at a cross-point between the input port and the output port. A collimation-maintaining fluid is disposed in the at least one trench, wherein the collimation-maintaining fluid has a refractive index substantially the same as the refractive index of the core portion. The switch also includes at least one movable switching element having an open position and a closed

position for directing the light signal into the output port. The at least one movable switching element is disposed in the at least one trench and substantially immersed in the collimation-maintaining fluid when in the open position and in the closed position.

In another aspect, the present invention includes a method for making an optical switch for transmitting a light signal. The method includes the steps of: forming a substrate, forming an optical waveguide layer having a predetermined index of refraction on the substrate, and forming a plurality of waveguide structures in the optical waveguide layer. A plurality of trenches are formed in the plurality of waveguide structures. A plurality of movable mirrors and actuators are formed on the substrate. A plurality of movable mirrors and actuators are disposed in the plurality of trenches. The plurality of trenches are filled with a collimation-maintaining fluid having an index of refraction that is substantially the same as the index of refraction of the optical waveguide layer, wherein the collimation-maintaining fluid substantially immerses each of the plurality of movable mirrors and actuators; and, sealing the optical switch.

Additional features and advantages of the invention will be set forth in the detailed description which follows, and in part will be readily apparent to those skilled in the art from that description or recognized by practicing the invention as described herein, including the detailed description which follows, the claims, as well as the appended drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is plan view of a first embodiment of the present invention;

FIG. 2 is a sectional view of the first embodiment taken along lines 1-1 of FIG. 1, showing the relationship between the elements formed on the first substrate and the elements formed on the second substrate;

FIG. 3 is a three dimensional view of a second embodiment showing the sliding MEMS mirror assembly and the MEMS actuator;

FIG. 4 is a plan view of a third embodiment of the present embodiment, showing a hexagonal version of the optical switch;

FIGS. 5A to 5H are a diagrammatic view of the first embodiment of the present invention showing the optical switch at various stages of fabrication;

FIG. 6 is a detail view of the second embodiment of the present invention showing the MEMS assembly area;

5 FIG. 7 is a sectional view of the second embodiment of the present invention taken along lines 2-2 of FIG. 6, showing the MEMS assembly area before the MEMS mirror is rotated into position;

FIG. 8 is a sectional view of the second embodiment of the present invention taken along lines 2-2 of FIG. 6, showing the MEMS assembly area after the MEMS mirror is
10 rotated into position;

FIG. 9 is a sectional view of the second embodiment of the present invention taken along lines 2-2 of FIG. 6, showing fabrication details.

FIG. 10 is a detail view of the MEMS assembly area in accordance with an alternate embodiment of the present invention;

15 FIG. 11 is a sectional view of a fourth embodiment of the present invention;

FIG. 12 is a schematic view of the integrated addressing electronics for the fourth embodiment of the present invention;

FIG. 13 is a schematic of the addressing electronics for a fifth embodiment using thermal actuators; and

20 FIG. 14 is an equivalent circuit diagram of the schematic depicted in Figure 13.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

25 Reference will now be made in detail to the present preferred embodiments of the invention, examples of which are illustrated in the accompanying drawings. Wherever possible, the same reference numbers will be used throughout the drawings to refer to the same or like parts. An exemplary embodiment of the optical switch of the present invention is shown in Figure 1, and is designated generally throughout by
30 reference numeral 1.

In accordance with the invention, the present invention for an optical switch includes a movable MEMS mirror 22 disposed in a trench 15 that is filled with a non-

conducting, low-viscosity, index-matching fluid 30. The index-matching fluid 30 functions as a collimation-maintaining fluid that prevents the light beam from spreading in switch cross-points 29. Because the light signal remains collimated in the switch cross-points, smaller mirrors are used, resulting in smaller actuation distances, and hence, shorter actuation times. The preferred embodiment of the present invention is hereinafter described in greater detail with reference to the accompanying drawings.

FIG. 1 is a plan view of an optical switch 1 of the first embodiment of the present invention. The switch 1 is a waveguide matrix formed from a waveguide core material 13 and clad material 14, which are deposited on first substrate 10. The core 13 and the cladding 14 are arranged on first substrate 10, to form a plurality of input waveguides 11 and a plurality of output waveguides 12. A plurality of trenches 15 are formed at cross-points 29 wherein input waveguides 11 intersect output waveguides 12. One of ordinary skill in the art will recognize that there are several ways to form the trenches 15. First, the trenches 15 can be formed as shown in FIG. 1, as continuous diagonal channels that intersect a plurality of cross-points. Alternatively, the trenches 15 can be disposed as discrete wells, formed separately and intersecting a single cross-point.

A plurality of independently movable switching elements 20 are disposed in trenches 15 at each cross-point 29. Each switching element 20 can be independently moved between an open position and a closed position. In the open position, light is allowed to propagate through the switch cross-points 29. In the closed position, switching element 20 is moved into the cross-point 29 to direct light into the output waveguide 12.

The operation of switch 1 is as follows. A light signal L_s enters switch 1 by way of input port 18. The light signal L_s propagates within input waveguide 11 until it is deflected into the output waveguide 12 by the switching element 20, which is in the closed position. Light signal L_s exits switch 1 from output port 19. Note also that two-sided switches can be used route light along multiple paths. Switch 20' is shown directing light signal L_s' to output port 19'. Thus, the present invention can be configured as an $N \times M$ non-blocking cross-bar switch.

FIG. 2 is a sectional view of the optical switch 1 taken along lines 1-1 as depicted in FIG. 1. In the first embodiment, switching elements 20 are formed on a second substrate 40. The second substrate 40 is then aligned with the first substrate 10 such

that the switching elements 20 are disposed in the plurality of trenches 15. The first substrate 10 is connected to the second substrate 40 by flip-chip bonding or similar methods at connection interface 17. In a third embodiment, which will be discussed subsequently, switching elements 20 can be formed on the first substrate 10. In this embodiment, the second substrate 40 functions merely as a cover for the switch 1.

Switching element 20 includes a sliding MEMS mirror 22, mirror anchor 23, MEMS chip 21, and an actuator 25, which is not shown in this view. The sliding mirror 22 is connected to MEMS chip 21 by mirror anchor 23, disposed in trench 15, and immersed in collimation maintenance fluid 30. The collimation maintenance fluid 30, is preferably a non-conducting, low viscosity fluid that has a refractive index that is closely or substantially matched to the refractive index of the core material 13. Electrically non-conducting fluid is required for all electrostatic actuators, but is not required for magnetic actuators. When using thermal actuators to implement the design, the fluid should not be of low thermal conductivity.

Mirror 22 is immersed in fluid 30 for both the open and closed switching positions. This yields distinct advantages over the related art. Typically, a light signal propagating in core 13 is collimated. When it enters the trench 15, the fluid 30 maintains collimation because it is matched to the refractive index of the core. Because beam spreading is mitigated by the fluid 30, a smaller mirror structure can be used. In the present invention, MEMS mirror 22 is only $15\mu\text{m}$ wide and $2\mu\text{m}$ thick.

The trench 15 is only $6\mu\text{m}$ to $10\mu\text{m}$ wide. As a result, a much shorter actuation distance, on the order of $15\mu\text{m}$, is achieved. This is a significant improvement over the related art that has actuation distances of $300\mu\text{m}$ to $400\mu\text{m}$. This improvement also results in an optical switch 1 having a much shorter switching time of approximately $370\mu\text{sec}$, as compared to 10msec for a $400\mu\text{m}$ mirror. Note that trench 15 must be etched to a sufficient depth to allow mirror 22 to eclipse substantially all ($> 99\%$) of the modal energy of the light signal when in the reflecting position. In one embodiment, the trench is $6\mu\text{m}$ wide, providing $2\mu\text{m}$ clearance on either side of the $2\mu\text{m}$ mirror 22. Those of ordinary skill in the art will appreciate that other structures, such as gratings and refracting elements, can be used to implement switching element 20.

In an alternate embodiment of the present invention, waveguides 11 and 12 have a $\Delta_{1,2} \sim 0.5\%$. One of ordinary skill in the art will recognize that $\Delta_{1,2}$ is defined as:

wherein n_1 is the refractive index of the core and n_2 is the refractive index of the

$$\Delta_{1,2} = \frac{n_1^2 - n_2^2}{2n_1^2},$$

cladding. By raising $\Delta_{1,2}$ from 0.34% (matched to the fiber industry standard SMF-28) to 0.5%, a savings of 5-7 μm in actuation distance and 5 μm in trench depth is obtained.

FIG. 3 is a three dimensional view of the second embodiment. Slider 24 is disposed on the floor of trench 15. Sliding MEMS mirror 22 is connected to the slider 24 by the mirror anchor 23, shown schematically. MEMS mirror 22 is moved between an open position and a closed position by MEMS actuator 25, which moves the slider 24 in and out of the cross-point 29 depending on the desired switch position. The MEMS actuator 25 can be implemented in several ways that are widely known in the art.

MEMS actuator 25 can be implemented using an electrostatic actuator, such as a scratch drive or a comb drive. A magnetic actuator can also be used in the design. A thermal actuator is a third method that can be used to implement actuator 25. Note that in FIG. 3 the collimation maintenance fluid 30 is not shown for clarity of illustration.

However, the fluid 30 plays an important role in the machining requirements of waveguide facets 16. These requirements can be relaxed for two reasons: first, because collimation-maintenance fluid 30 inhibits beam spreading; and second, because the facets 16 are not used to reflect the light signal during switching. In FIG. 3, the facets 16 form an angle of approximately 45° with the face of the sliding MEMS mirror 22.

However, because of the relaxed requirements, the angle need not be 45°. The angle could in fact be any arbitrary value between 0° and 45°.

FIG. 4 is a plan view of a third embodiment of the present embodiment, depicting a hexagonal version of the optical switch 70. There are three linear arrays of input waveguides 71, 73, and 75 arranged on a first, third, and fifth side of hexagonal switch 70. There are three linear arrays of output waveguides 72, 74, and 76 arranged on a second, fourth, and sixth side of hexagonal switch 70. A two dimensional array of trenches 77 are disposed at cross-points 701 where the input optical waveguides 71, 73, and 75 intersect the output optical waveguides 72, 74, and 76. A plurality of

independently movable switching elements, only one of which is shown for clarity of illustration, are disposed in trenches 77 at each cross-point 701. The switching elements of the second embodiment operate in the same manner as switching elements 20 of the first embodiment. Those skilled in the art will appreciate that other polygon array geometries could be used.

FIGS. 5A to 5G are diagrammatic views of the first embodiment of the present invention showing the optical switch at various stages of fabrication. FIG. 5A shows the formation of a first substrate 10. First substrate 10 can be formed using any of the methods and materials commonly known to those of ordinary skill in the art. Such methods may include glass-forming methods, use of semiconductor materials such as silicon, chemical vapor deposition of silica, fused silica, ceramic materials, metallic materials, or polymeric materials.

In FIG. 5B, an optical waveguide layer 11 is formed on substrate 10. A variety of methods and materials can be used to form Layer 11, including: sol-gel deposition of silica; amorphous silicon; compound semiconductor materials such as III-V or II-VI materials; doped chemical vapor deposition of silica; organic-inorganic hybrid materials; or polymer materials. Layer 11 includes waveguide core material 13 and waveguide clad material 14. The waveguide structures 130 are then formed using photolithographic techniques wherein layer 11 is selectively exposed to radiation. Excess material is removed to form the waveguide structures 130. In another method, waveguide structure material is deposited in a groove etched in the cladding material to form the waveguide structure 130. Other techniques such as embossing and micro replication can also be used to form the waveguide structures 130.

FIG. 5C shows a plurality of trenches 15 being formed in the waveguide structure 130. Photolithographic techniques are used to form trenches 15 on the waveguide structures 130. Excess material is removed by etching.

In FIGS. 5D TO 5G, a preferred method of fabricating the switching element 20 is described. In this example, the fabrication of the switch element 20 is carried out using micro-machining on a MEMS substrate. In FIG. 5D, a second substrate 40 is formed. An optional nitride layer 52, an oxide layer 50 and a polysilicon layer 51 are then deposited thereon. The image of the mirror 22 and hinge 28 are transferred onto the polysilicon layer using UV radiation. In FIG. 5E, a mold of the hinge and mirror is

formed when excess photoresist material is washed away. In FIG. 5F, the mold is filled with mirror material 60 and covered with an oxide layer 61. As is shown in FIG. 5G, after several intermediate steps wherein holes are drilled and excess material is removed, MEMS mirror 22 and anchor 23 remain on second substrate 40, to form a portion of switching element 20. Mirror 22 is coated with a layer of gold to form the mirrored surface. Subsequently, mirror 22 is rotated to form a right angle with substrate 40. It is noted that the MEMS actuator 25, which is not shown, is also part of switching element 20 and is formed during this process. The actuator 25 is omitted for clarity of illustration.

FIG. 5H depicts the final step of fabrication. Second substrate 40 is aligned with the first substrate 10 and mirror 22 is inserted into trench 15. The first substrate 10 is then connected to the second substrate 40 by bonding or some other means. The trenches are filled with fluid 30 using access holes, which are then sealed.

FIG. 6 is a detail view of a second embodiment of the present invention showing the MEMS assembly area 26. The assembly area 26 is used when the switching element 20 is formed integrally with substrate 10 using the surface micro-machining fabrication technique. The assembly area 26 is formed in that portion of the trench 15 that is situated between waveguide cross-points 29. The purpose of the assembly area is to provide the necessary area for fabricating the mirror 22 and rotating it into its operational position.

FIG. 7 is a sectional view of FIG. 6, taken along lines 2-2 showing the MEMS assembly area before the MEMS mirror is rotated into position. The mirror 22 is shown parallel to the assembly area floor 27 immediately after fabrication. The last step in the fabrication of the switch is to rotate mirror 22 around the hinge 28 into a position perpendicular to assembly floor 27. FIG. 8 is also sectional view of FIG. 6, taken along lines 2-2 showing the MEMS assembly area after the MEMS mirror is rotated into position. After the mirror 22 is rotated, it is then able to slide along slider track 24 inside trench 15 toward the waveguide cross-points 29.

One of ordinary skill in the art will recognize that other methods are used to fabricate the mirrors 22 and the actuators 25. LIGA technology is well suited for this purpose. LIGA uses deep X-ray lithography to expose an X-ray sensitive resist layer. The excess resist is removed and the resulting relief is electroplated. The resulting form

is a highly accurate metal structure that can be used as a master for injection molding or compression molding processes, or it can be used as the desired structure itself. Bulk micro-machining by anisotropic etching of (110) silicon is another suitable method of fabrication. This technique has advantages over the surface micro-machining process. When using the bulk micro-machining technique, the mirror 22 does not have to be rotated as depicted in the sequence shown in FIGS. 7-8. The bulk micro-machining technique allows the mirror 22 to be fabricated in a position perpendicular to the substrate 10 as shown in FIG. 8, but without the hinge. The hinge is not needed because the mirror does not have to be rotated into its operational position. This technique would allow for the gold-plating of both sides of the mirror to implement a two-way switch. Another advantage is that the silicon surface is smoother as a result of the bulk micro-machining technique. Silicon-on-insulator technology (SOI) and Single Crystal Reactive Etching and Metallization (SCREAM) process technology can also be used to fabricate mirrors 22 and actuators 25.

In an alternate embodiment of the present invention, as embodied herein and depicted in FIG. 9, the second substrate 40 functions only as a cover. The first substrate 10 is then connected to the second substrate 40 by bonding or some other suitable means. The trenches are then filled with fluid 30 using access holes, which are then sealed.

As embodied herein and depicted in FIG. 10, a detail view of the MEMS assembly area 26 in accordance with an alternate embodiment of the present invention is disclosed. In figure 10, MEMS assembly area 26 is fabricated by flaring the side walls of trench 15 out to produce a wider gap. The flaring of the side walls is introduced away from switch cross-point 29 to minimize optical impairment. The wider gap provides more area for the initial assembly of mirror 22.

As embodied herein and depicted in FIG. 11, a sectional view of a fourth embodiment of the present invention is disclosed. Optical switch 1 includes first substrate 10 and second substrate 40. First substrate 10 has a core portion 13 and cladding 14 deposited thereon to form waveguides 11 and 12. Trench 15 is formed at cross-point 29 where waveguide 11 and waveguide 12 intersect. Collimation-maintaining fluid 30 is disposed in trench 15. Collimation-maintaining fluid 30 has a refractive index substantially the same as the refractive index of core portion 13.

Movable mirror 22 has an open position for allowing light to continue to propagate along core 13 and a closed position for directing the light signal into output port 19 (not shown). Mirror 22 is disposed in trench 15 and substantially immersed in collimation-maintaining fluid 30 when in either the open position or the closed position. Mirror 22 includes patterned beam 220 that is used to anchor mirror 22 to cladding 14. Substrate 40 has electrostatic actuator 25 deposited thereon. Actuator 25 is connected to transistor 250. Transistor 250 is connected to individually addressable electrode 252. Thus, a two-dimensional array of transistors 252 is integrated on substrate 40, wherein each cross-point 29 in optical switch 1 has its own addressable electrode 252. The integrated electronics (electrodes 250 and transistors 252) are assembled on substrate 40 using pick and place technology or integrated directly on a silicon wafer deposited on substrate 40. Thus, first substrate 10 is an optical substrate that includes an $N \times M$ array of waveguides and second substrate 40 is an electrical substrate that includes the actuation and addressing scheme for the $N \times M$ array. One of ordinary skill in the art will recognize that the $N \times M$ array forms a non-blocking cross-bar switch.

Switch 1 in Figure 11 operates as follows. When electrode 252 is de-energized, transistor 250 provides no power to actuator 25 and mirror 22 is in the closed position. Hence, light is reflected by mirror 22 into output port 19 (not shown). When power is applied to electrode 252, transistor 250 is energized and an electrostatic force is present on actuator 25. Plate 220 is flexed upward by the electrostatic force and mirror 22 is lifted out of trench 15 into an open switch position. Light passes through cross-point 29 and continues to propagate along core 13.

As embodied herein and depicted in Figure 12, a schematic view of the integrated addressing electronics 400 for the fourth embodiment of the present invention is disclosed. In an $N \times M$ switch, wherein $N = M = 16$ or greater, it is impractical to individually address each transistor 250 with its own electrodes 252. Each gate and drain would need its own electrode. This results in $2 \times N \times M$ electrodes. In Figure 12, electrical substrate 40 includes column addressing lines $C_1 \dots C_N$ and row addressing lines $R_1 \dots R_M$. Each column address line C_i is connected to the gate of each transistor 250 in the column C_i . Each row address line R_j is connected to the drain of each transistor in the row R_j . The source of each transistor 250 is connected to the individual electrostatic actuators 25. One of ordinary skill in the art will recognize that

actuator 25 and beam 220, as shown in Figures 11 and 12, form the upper and lower plates of a capacitor. One of ordinary skill in the art will also recognize that integrated addressing electronics 400 can also be used with magnetic actuators.

Transistor 250 may be of any suitable type, but there is shown by way of example thin film transistors disposed on a glass substrate. One of ordinary skill in the art will recognize that substrate 40 can be implemented as an integrated high voltage CMOS chip that includes transistors 250 and address lines C_i , R_j . Address lines C_i , R_j are connected to a controller (not shown) that drives the electronics and hence, the actuators in accordance with network commands. High voltage CMOS is required because the voltage needed to drive the actuators is within an approximate range between 70V and 125V. One of ordinary skill in the art will recognize that the exact voltage required for a given application is dependent upon the size of the transistor and its leakage current.

Addressing electronics 400 operate as follows. The controller activates one column at a time. After a column C_1 is activated with a high voltage, the controller places a control word on the row address lines $R_1..R_M$. For example, for system having $R_1 - R_4$, a control word 1010 would result in R_1 and R_3 being supplied with a high voltage, and R_2 and R_4 being grounded. Subsequently, C_1 is de-activated and C_2 is activated. Again the controller places a control word on the row address lines $R_1..R_M$. In like manner, each actuator 25 is actuated one column at a time until switch 1 is in the desired state. One of ordinary skill in the art will recognize that for a non-blocking switch, only one actuator is turned on in any one row or column at a time.

As embodied herein and depicted in Figure 13, a schematic of the addressing electronics 500 for a switch using thermal actuators is disclosed. Thermal actuators are well known in the art. As current flows, the device heats and expands causing the mirror 22 to move along the sliding track 24 (as shown in Figure 3). In this embodiment, electronics 500 are disposed on the optical substrate 10. Diode 260 is added in series with actuator 25. Diode 260 limits the flow of current to one direction through all of the actuators. Use of diodes 260 eliminates all current paths opposite to the intended row-to-column or column-to-row direction. In this embodiment, note that column C_1 is activated by being pulled low, in this case, by V_- . Row R_4 is addressed using a high voltage V_+ . Thus, a current flows through diode 260. If C_1 were pulled

high and R4 were pulled low, diode 260 prevents current from flowing in the reverse direction.

FIG. 14 is an equivalent circuit diagram of the schematic depicted in Figure 13. As shown, when voltage is applied to row R4 and column C1, all paths going from column terminals C2, C3, or C4, to the row terminals R1, R2, or R3 are blocked by diodes. Since the only remaining current paths are those at the intersection of the activated row and column, all unwanted current paths are eliminated. This is a critical innovation. If diodes 260 are not present, unintended current paths are generated causing unwanted power dissipation in actuators 25 not being addressed. As shown in Figure 14, there are numerous paths that do not flow through the targeted actuator, for example from row R4, column C1 through row R1, column C2. Diode 262 in Figure 14, eliminates this unwanted current. The undesirable currents impair performance in two ways. First, they increase the total power required to actuate the device. In a 4 x 4 array, 56% of the total power is wasted on incidental actuators. This assumes that the resistance value for each actuator is the same. In a 32 x 32 array, 94% of the power is wasted on incidental actuators. Second, the unwanted currents may partially actuate a mirror resulting in optical insertion loss and cross-talk. Thus, the inclusion of diodes 260 eliminate these problems.

Diodes 260 may be of any suitable type, but there is shown by way of example diodes fabricated by a thin film deposition technique. Diodes 260 can also be fabricated using ion implantation or thermal diffusion. Diodes 260 can also be fabricated on an external substrate much like the fourth embodiment depicted in Figures 11 and 12.

While specific embodiments of the invention have been shown and described in detail, it will be understood that the invention may be modified without departing from the spirit of the inventive principles as set forth in the hereinafter claims. Thus, it is intended that the present invention cover the modifications and variations of this invention provided they come within the scope of the appended claims and their equivalents.

What is claimed is:

1. An optical switch for directing a light signal, said optical switch comprising:
 - at least one optical waveguide having an input port, an output port, and a core portion having a refractive index n_1 ;
 - at least one trench formed in said at least one optical waveguide at a cross-point between said input port and said output port;
 - a collimation-maintaining fluid disposed in said at least one trench, wherein said collimation-maintaining fluid has a refractive index substantially the same as said refractive index of said core portion; and
 - at least one movable switching element having an open position and a closed position for directing the light signal into said output port, said at least one movable switching element being disposed in said at least one trench and substantially immersed in said collimation-maintaining fluid when in said open position and in said closed position.
2. The optical switch of claim 1, wherein the at least one movable switching element comprises:
 - an actuator; and
 - a reflecting element.
3. The optical switch of claim 2, wherein the reflecting element further comprises:
 - a plate covering the at least one trench; and
 - a mirror element connected to said plate and extending from said plate into the at least one trench.
4. The optical switch of claim 3, wherein the plate is moved by electrostatic attraction when the electrostatic actuator is energized, causing the mirror element to move within the at least one trench into the open position.
5. The optical switch of claim 4, wherein the plate is in a quiescent state when the electrostatic actuator is not energized, causing the mirror element to be in the closed position.

6. The optical switch of claim 2 wherein the reflecting element is a grating.

5 7. The optical switch of claim 2, wherein the reflecting element is a MEMS movable mirror.

8. The optical switch of claim 7, wherein the movable mirror moves between the open position and the closed position, or the closed position and the open position, in a time period that is approximately 370 μ sec or greater.

10 9. The optical switch of claim 7, wherein the movable mirror has a thickness of approximately 2 μ m and a width of approximately 15 μ m.

15 10. The optical switch of claim 7, wherein the mirror is slidably mounted at least partially within the trench.

11. The optical switch of claim 7, wherein the mirror is pivotally connected within the trench.

20 12. The optical switch of claim 2, wherein the actuator comprises a comb drive actuator.

25 13. The optical switch of claim 2, wherein the actuator comprises a scratch drive actuator.

14. The optical switch of claim 2, wherein the actuator comprises a thermal actuator.

15. The optical switch of claim 2, wherein the actuator comprises a magnetic actuator.

30 16. The optical switch of claim 2, wherein the actuator comprises an electrostatic actuator.

17. The optical switch of claim 1, wherein the at least one movable switching element comprises:

- an actuator; and
- a refracting element.

18. The optical switch of claim 1, wherein the at least one trench has a width that is in an approximate range between 6 microns and 10 microns.

19. The optical switch of claim 18, wherein the at least one trench has a width approximately equal to 6 microns.

20. The optical switch of claim 1, wherein the at least one movable switching element has an actuation distance of approximately 15 μ m.

21. The optical switch of claim 21, wherein Δ_{1-2} is substantially equal to 0.34%.

22. The optical switch of claim 21, wherein Δ_{1-2} is substantially equal to 0.5%.

23. The optical switch of claim 1, wherein the at least one optical waveguide comprises:

- a plurality of input optical waveguides; and
- a plurality of output optical waveguides that intersect said plurality of input optical waveguides at a plurality of cross-points, wherein the at least one trench includes a plurality of trenches formed at said plurality of cross-points.

24. The optical switch of claim 23, wherein the at least one movable switching element is a plurality of movable switching elements, such that each of said movable switching elements is disposed in a corresponding trench of the plurality of trenches.

25. The optical switch of claim 24, further comprising:
a first substrate; and

a second substrate connected to said first substrate for encapsulating the collimation-maintaining fluid within the plurality of trenches.

26. The optical switch of claim 25, wherein the plurality of input waveguides and the plurality of output waveguides are formed on the first substrate and the plurality of movable switching elements are formed on the second substrate.

27. The optical switch of claim 26, further comprising a seal or a bond at a location where the first substrate is connected to the second substrate.

28. The optical switch of claim 25, wherein the plurality of input waveguides, the plurality of output waveguides, and the plurality of movable switching elements are integrally formed on the first substrate.

29. The optical switch of claim 28, wherein the plurality of movable switching elements, the plurality of input waveguides, and the plurality of output waveguides form an $N \times M$ non-blocking cross-bar switch, wherein N is the number of input waveguides, M is the number of output waveguides and $N \times M$ is the number of movable switching elements.

30. The optical switch of claim 28, wherein each of the plurality of movable switching elements further comprises:

a beam connected to the first substrate, said beam being cantilevered to cover the trench; and

a mirror element connected to said beam and extending from said beam into said trench.

31. The optical switch of claim 30, further comprising a two dimensional array of electrostatic actuators disposed on the second substrate, wherein each electrostatic actuator of said array of electrostatic actuators is aligned with a corresponding movable switching element in the array of movable switching elements.

32. The optical switch of claim 31, wherein the plate is moved by electrostatic attraction when the electrostatic actuator is energized, causing the mirror element to be moved within the trench into the open position.

5 33. The optical switch of claim 31, wherein the plate is in a quiescent state when the electrostatic actuator is not energized, to thereby cause the mirror element to be in the closed position.

34. The optical switch of claim 31, further comprising:

10 a transistor connected to the electrostatic actuator for supplying electrical power to the electrostatic actuator in an energized state; and
an electrode connected to said transistor for supply electrical power to said transistor in an energized state.

15 35. The optical switch of claim 24, further comprising:

a first optical substrate having the plurality of input optical waveguides, the plurality of output optical waveguides, and the plurality of movable switches disposed therein; and

20 a second electrical substrate connected to said first substrate, said second substrate having a plurality of actuators corresponding to the plurality of movable switches, wherein each of the plurality of actuators actuates a corresponding one of the plurality of movable switches.

25 36. The optical switch of claim 35, wherein the second electrical substrate includes a plurality of electrodes for individually addressing the plurality of actuators to form a non-blocking cross-bar switch.

37. The optical switch of claim 36, wherein the actuator comprises a magnetic actuator.

30 38. The optical switch of claim 36, wherein the actuator comprises an electrostatic actuator.

39. The optical switch of claim 1, wherein the at least one optical waveguide, the at least one trench, and the at least one movable switching element are arranged in a polygon configuration.

5 40. The optical switch of claim 39, wherein the polygon configuration is a hexagon configuration.

41. The optical switch of claim 40, wherein the at least one optical waveguide comprises:

10 three linear arrays of input optical waveguides arranged on a first, a third, and fifth side of the hexagon configuration; and,
 three linear arrays of output optical waveguides arranged on a second, a fourth, and a sixth side of the hexagon configuration.

15 42. The optical switch of claim 41, wherein the at least one trench comprises a two dimensional array of trenches disposed at cross-points where the three linear arrays of input optical waveguides intersect the three linear arrays of output waveguides.

20 43. The optical switch of claim 1, wherein the at least one trench is a continuous diagonal channel that intersects the at least one optical waveguide at a plurality of cross-points.

44. The optical switch of claim 1, wherein the at least one trench is a discrete well, formed separately and intersecting a single cross-point.

25 45. A method for making an optical switch for transmitting a light signal, said method comprising the steps of:

forming a substrate;

forming an optical waveguide layer having a predetermined index of refraction on
30 said substrate;

forming a plurality of waveguide structures in said optical waveguide layer;

forming a plurality of trenches in said plurality of waveguide structures;

forming a plurality of movable mirrors and actuators on said substrate;
disposing a plurality of movable mirrors and actuators in said plurality of trenches;
filling said plurality of trenches with a collimation-maintaining fluid having an index
of refraction that is substantially the same as said index of refraction of said
optical waveguide layer, wherein said collimation-maintaining fluid substantially
immerses each of said plurality of movable mirrors and actuators; and,
sealing the optical switch.

46. The method according to claim 45, wherein the step of forming plurality of
waveguide structures is performed by a photolithographic process.

47. The method according to claim 45, wherein the step of forming a plurality of
waveguide structures is performed using a micro replication technique.

48. The method according to claim 45, wherein the step of forming a plurality of
waveguide structures is performed using an embossing technique.

49. The method according to claim 45, wherein the step of forming a substrate
comprises forming a first substrate and a second substrate.

50. The method according to claim 49, wherein the optical waveguide layer is formed
on the first substrate and the plurality of movable mirrors and actuators the are
formed on the second substrate.

51. The method according to claim 49, wherein the plurality of waveguide structures,
and the plurality of movable mirrors and actuators are integrally formed on the
first substrate.

52. The method according to claim 45 wherein the step of forming a plurality of
movable mirrors and actuators is performed by surface micro-machining on a
MEMS substrate.

53. The method according to claim 45, wherein the step of forming a plurality of movable mirrors and actuators is performed by micro-machining using LIGA technology.
54. The method according to claim 45, wherein the step of forming a plurality of movable mirrors and actuators is performed using Silicon on insulator technology.
55. The method according to claim 45, wherein the step of forming a plurality of movable mirrors and actuators is performed by micro-machining using SCREAM process technology.
56. The method according to claim 45, wherein the step of forming a plurality of movable mirrors and actuators is performed by micro-machining using bulk micro-machining by anisotropic etching.
57. An optical switch for directing a light signal, said optical switch including a first substrate having an input, a first output, and a second output connected to said input and first output at a cross-point, and a second substrate connected to said first substrate, said optical switch comprising:
- a switch element disposed in the cross-point, for directing the light signal propagating in the input into the first output when in a first state, or into the second output when in a second state, wherein said switch element is substantially immersed in a collimation-maintaining fluid in both said first state and said second state;
 - an actuator formed on said second substrate and coupled to said switch element, for moving said switch element between said first state and said second state; and
 - a circuit connected to said actuator for causing said actuator to move said switch element in accordance with said switch state.
58. An optical switch for directing a light signal, said optical switch including a first substrate and a second substrate, said optical switch comprising:

an optical circuit formed in the first substrate, said optical circuit includes a plurality of first waveguides intersecting a plurality of second waveguides; a plurality of cross-points formed at locations where said first optical waveguides intersect said second optical waveguides;

5 a plurality of movable switches disposed in said plurality of cross-points, each of said switches directs the light signal into one of said first optical waveguides in a first switch state or into one of said second optical waveguides in a second switch state, wherein each of said switches is substantially immersed in collimation-maintaining fluid when in either of said first switch state or said

10 second switch state; and

an integrated electronic system formed in the second substrate and coupled to said plurality of movable switches, said integrated electronic system selectively actuates each of the plurality of movable switches between said first switch state and said second switch state in accordance with a predetermined command.

15

59. The optical switch of claim 58, wherein the integrated electronic system further comprises:

a plurality of actuators disposed on said second substrate and coupled to the plurality of switches, wherein each of said plurality of actuators actuates one of said plurality of movable switches between said first switch state and said

20 second switch state; and

an integrated electrical addressing circuit formed in said second substrate for selectively actuating said plurality of actuators in accordance with a predetermined command.

25

60. The optical switch of claim 59, wherein the plurality of actuators are electrostatic actuators.

61. The optical switch of claim 59, wherein the plurality of actuators are magnetic actuators.

30

62. The optical switch of claim 59, wherein the integrated electrical addressing circuit further comprises:

- a plurality of column electrodes formed in the second substrate;
- a plurality of row electrodes formed in the second substrate and substantially electrically isolated from said column electrodes; and
- a plurality of transistors disposed on said second substrate, each of said plurality of transistors is connected to one of said plurality of column electrodes, one of said plurality of row electrodes, and one of the plurality of actuators, wherein said transistor supplies actuating power to said actuator only when it is addressed by both of said row electrode and said column electrode.

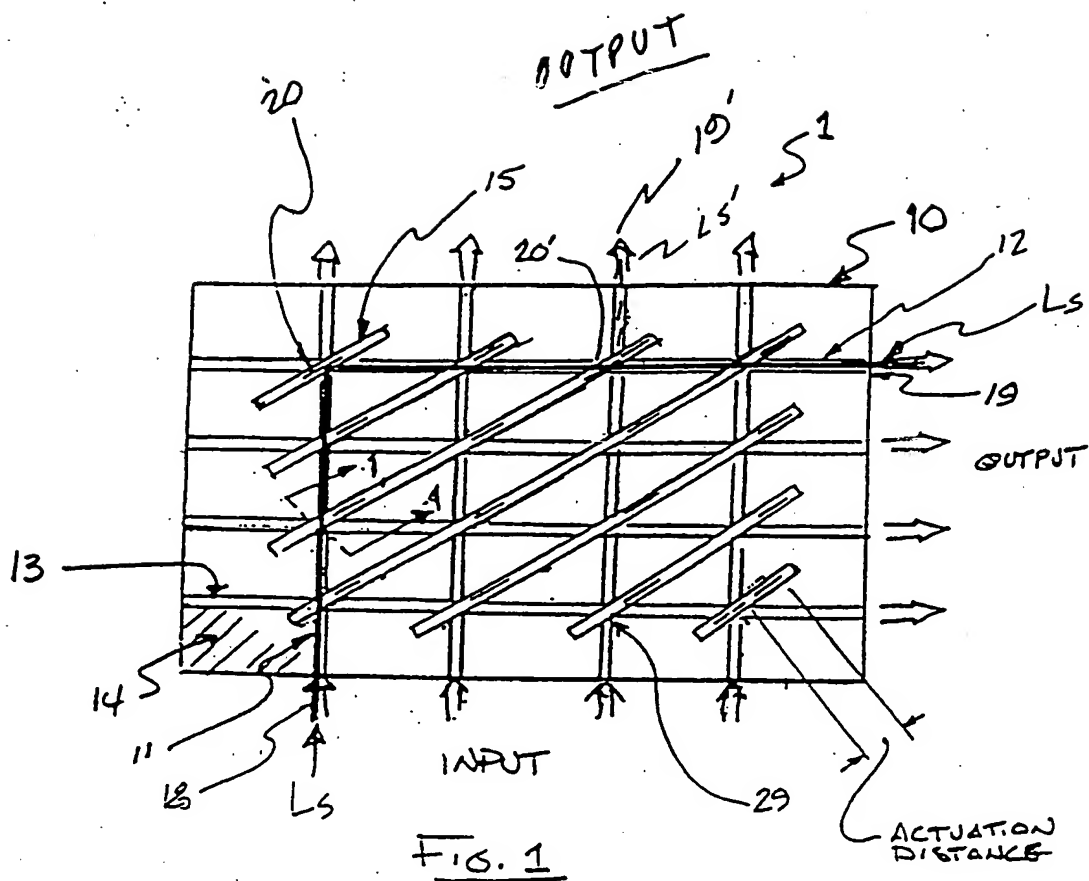
63. The optical switch of claim 62, wherein each of the plurality of row electrodes is supplied with a voltage in accordance with the predetermined command while energizing only one of the plurality of column electrodes to thereby address the plurality of transistors one column at a time.

64. The optical switch of claim 58, wherein the plurality of movable switches include a plurality of MEMS mirrors.

65. An optical switch for directing a light signal, said optical switch comprising:
an optical circuit having a plurality of first waveguides intersecting a plurality of second waveguides;
a plurality of movable switches disposed at locations where said first optical waveguides intersect said second optical waveguides, each of said plurality of movable switches directs the light signal into one of said first optical waveguides in a first switch state or into one of said second optical waveguides in a second switch state, wherein each of said switches is substantially immersed in collimation-maintaining fluid when in either of said first switch state or said second switch state; and
a thermal actuation system having a plurality of thermal actuators coupled to said plurality of movable switches, said thermal actuation system selectively actuates each of the plurality of movable switches between said first switch state and said

second switch state in accordance with a predetermined command, wherein said thermal actuation system prevents electrical current from flowing to movable switches not selected by said predetermined command.

- 5 66. The optical switch of claim 65, wherein the thermal actuation system comprises:
a plurality of column electrodes formed in the second substrate, wherein a column
electrode is activated by being grounded;
a plurality of row electrodes formed in the second substrate and substantially
10 electrically isolated from said column electrodes, wherein a row electrode is
activated by a positive voltage; and
a plurality of diodes, wherein each of said plurality of diodes is connected to one of
said row electrodes;
a thermal actuating element connected to said diode and to one of said column
15 electrodes, wherein current is prevented from flowing from said one column
electrode to said one row electrode.



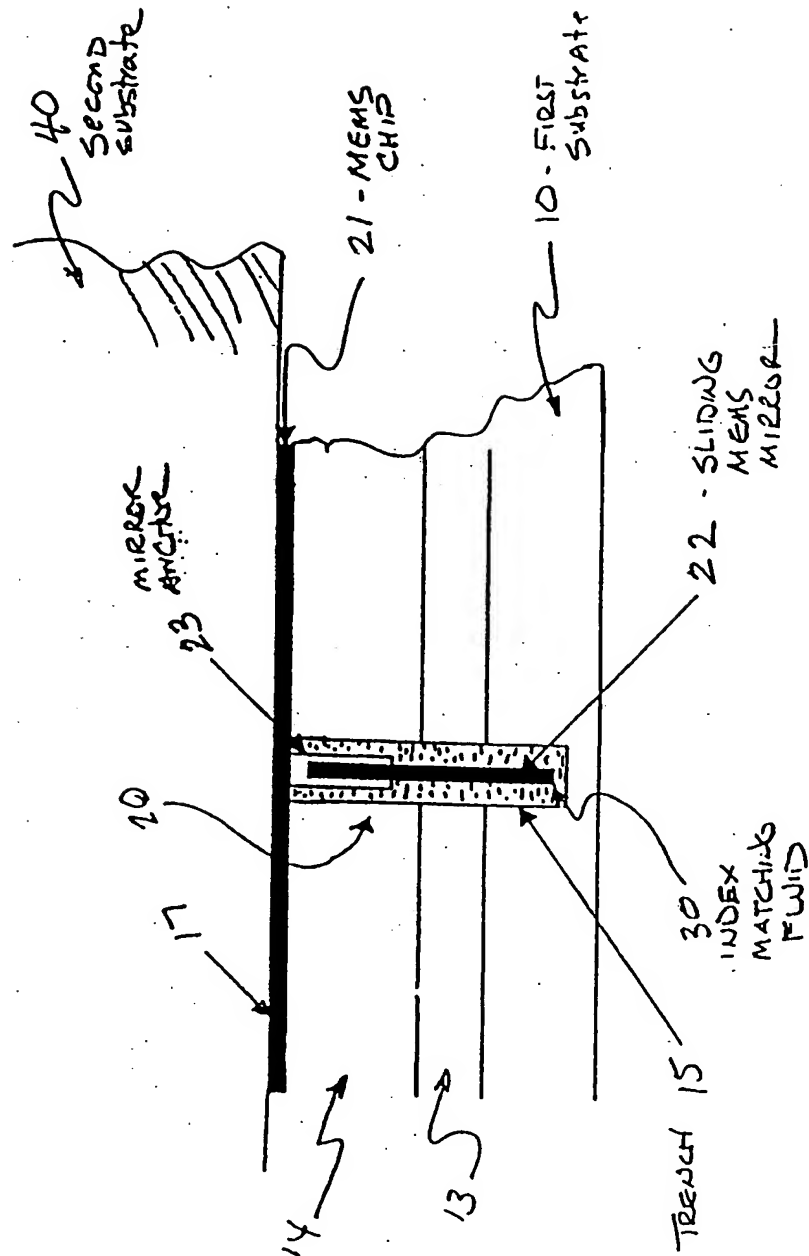
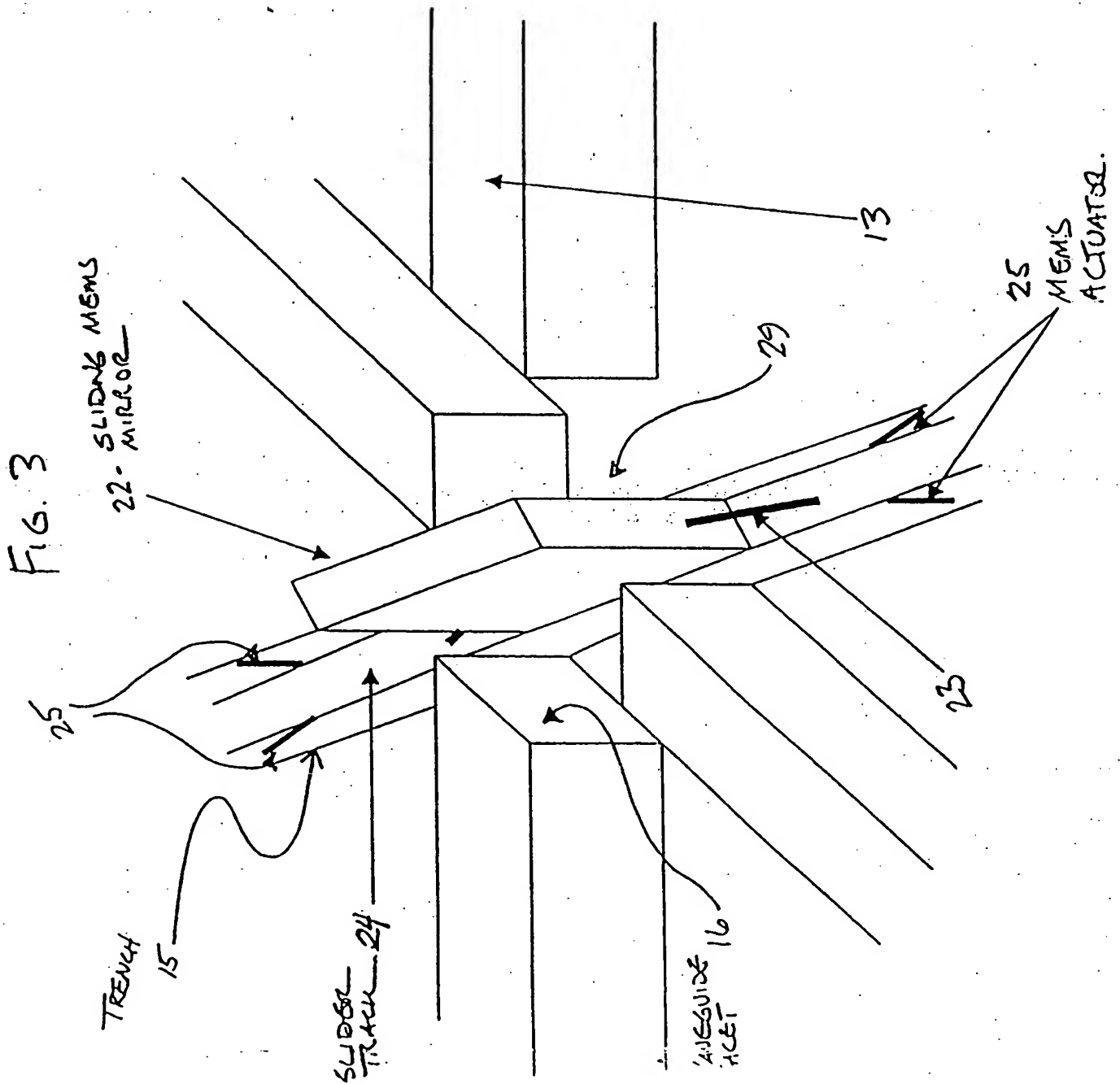


FIG. 2



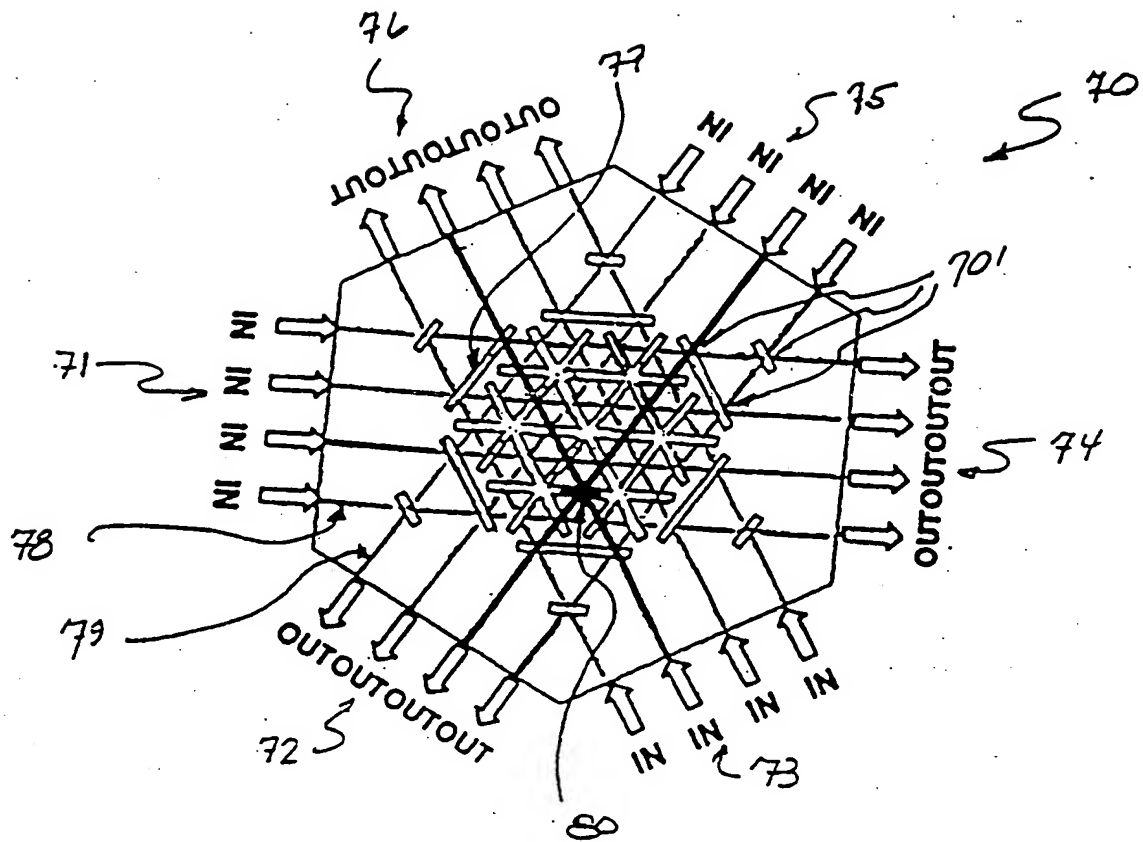


FIG. 4

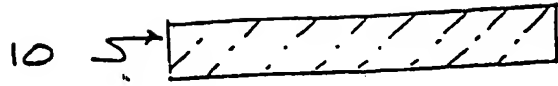


FIG 5A

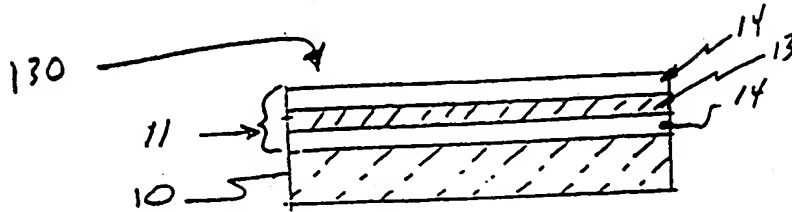


FIG 5B

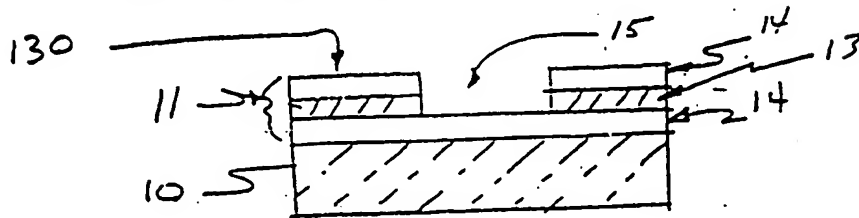


FIG 5C

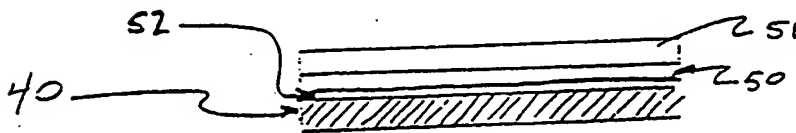


FIG 5D

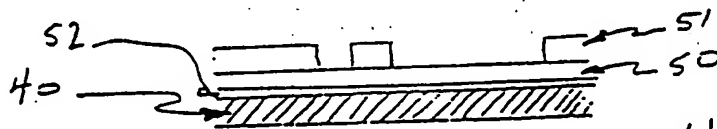


FIG 5E

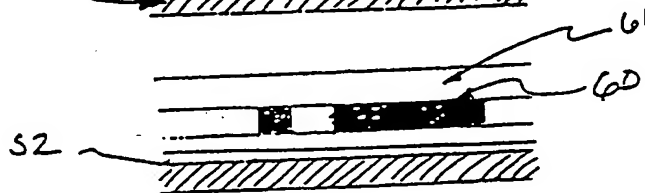


FIG 5F

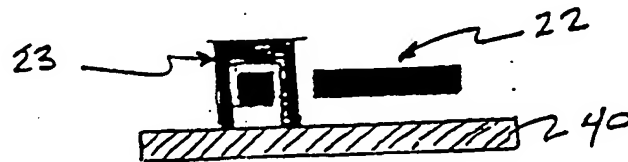


FIG. 5G

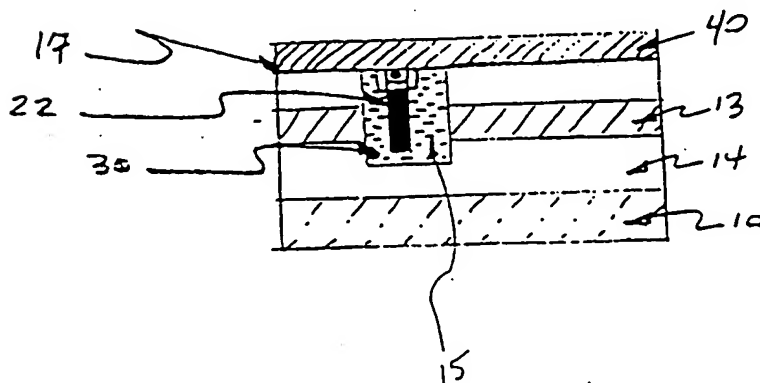
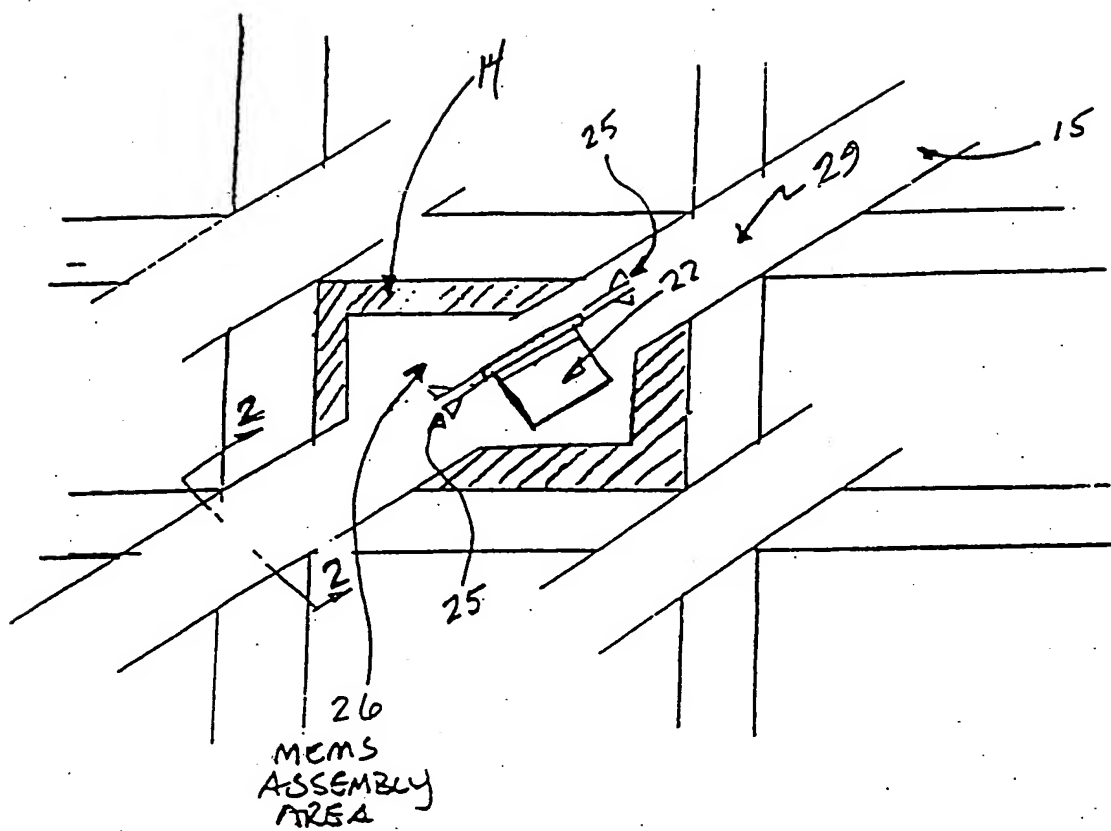


FIG. 5H

FIG. 6

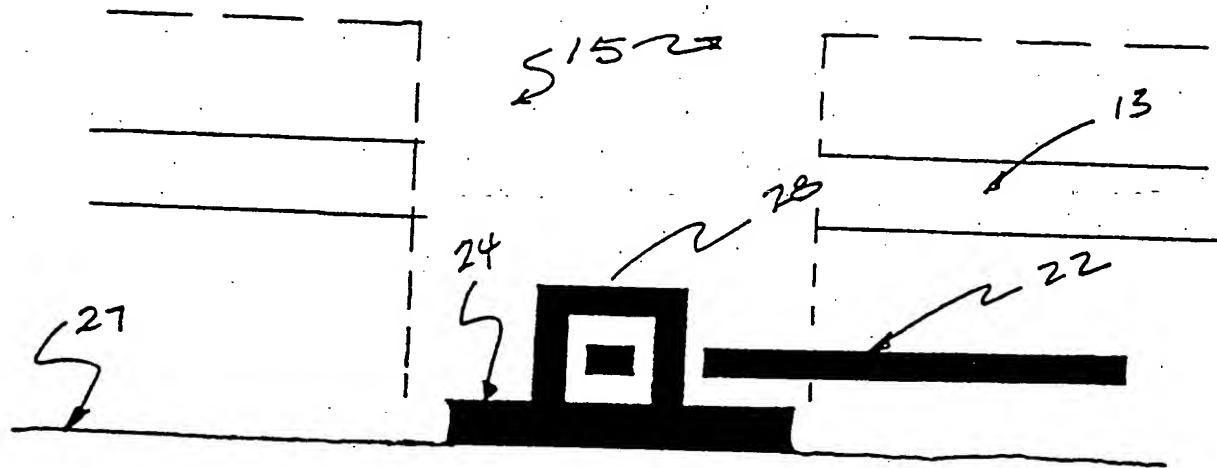


FIG. 7

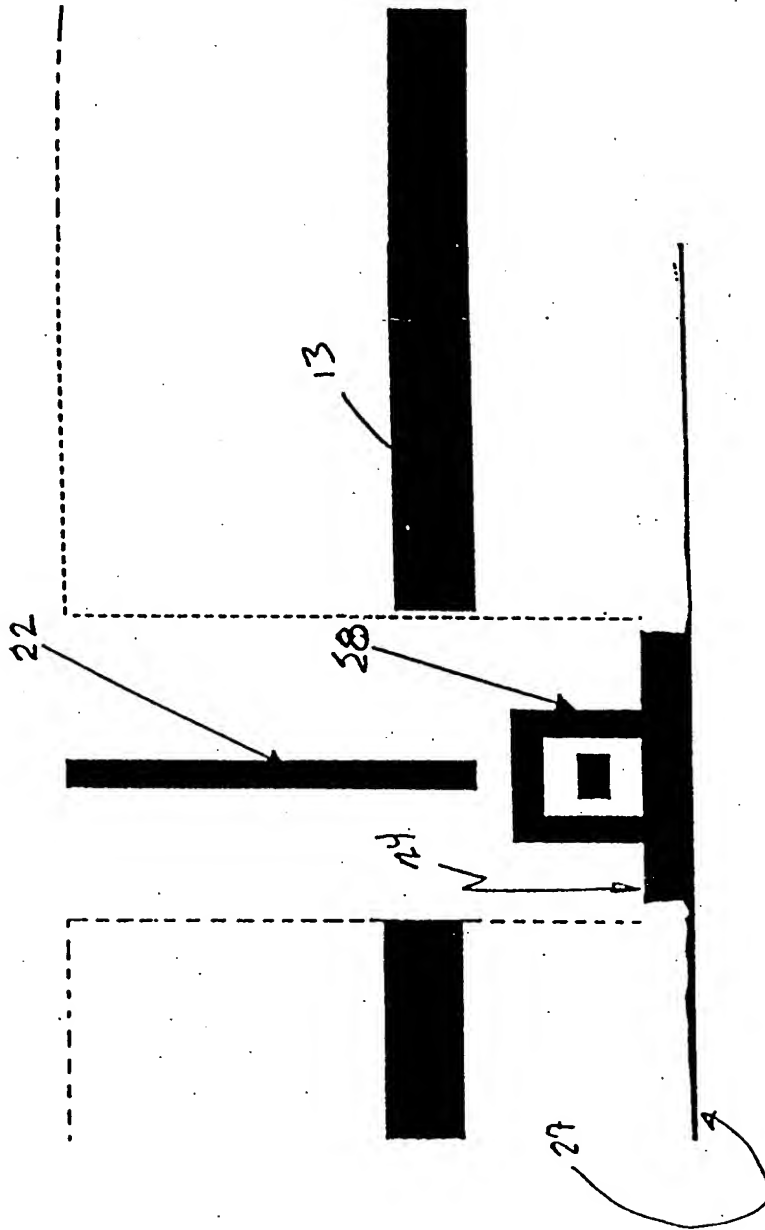


FIG 8

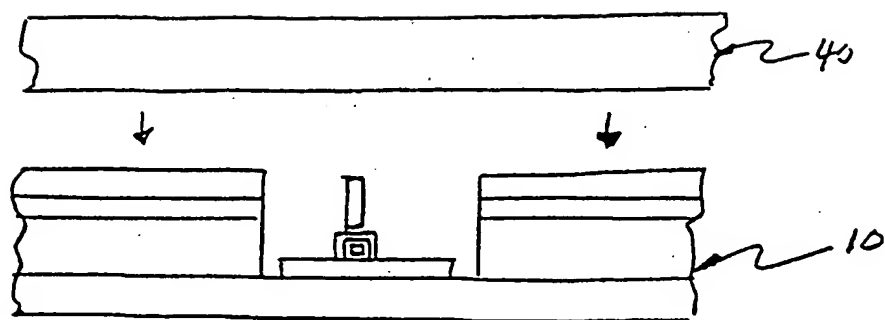


FIG. 9

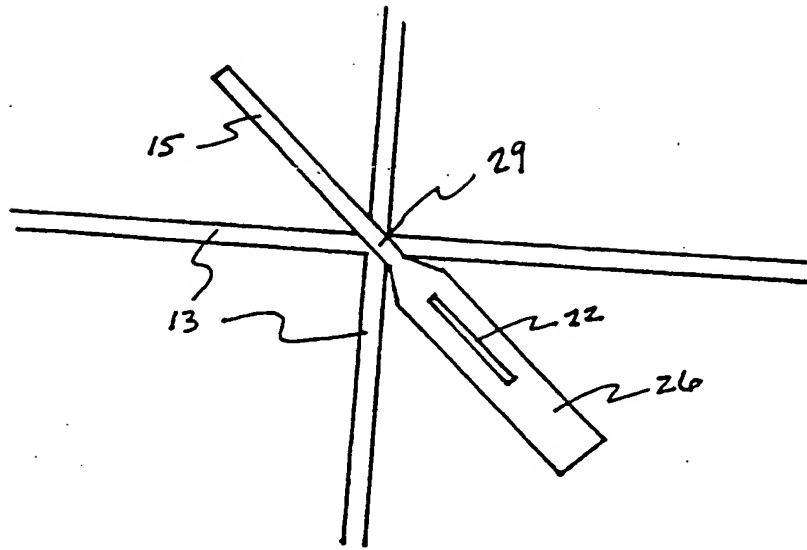


FIG. 10

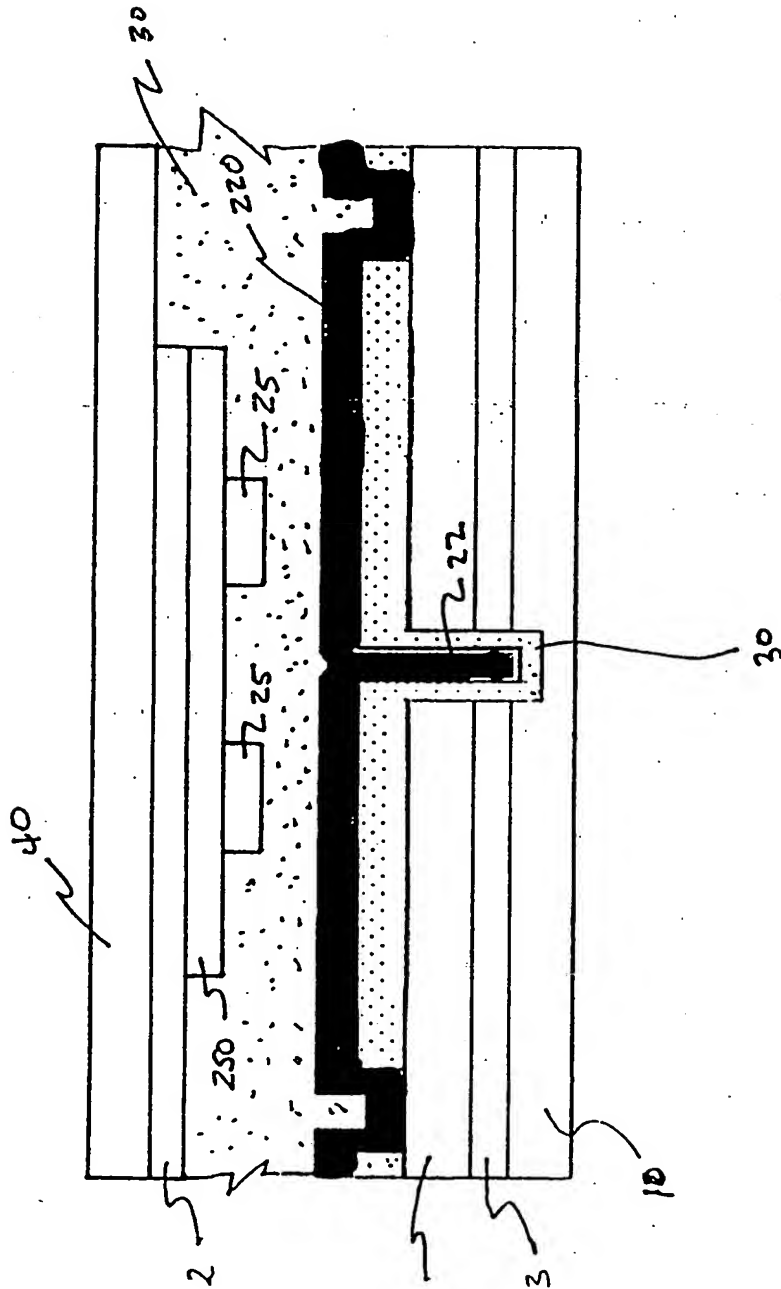


FIG. 11

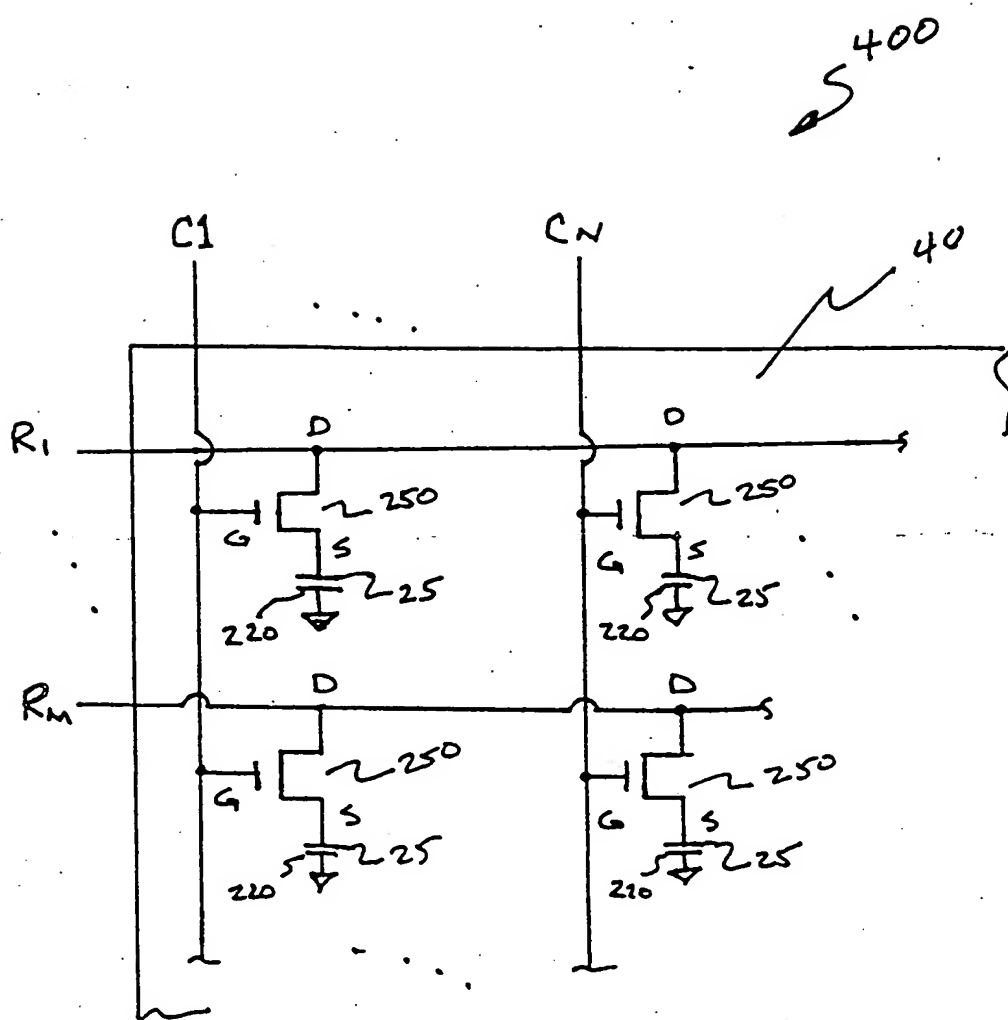


FIGURE 12

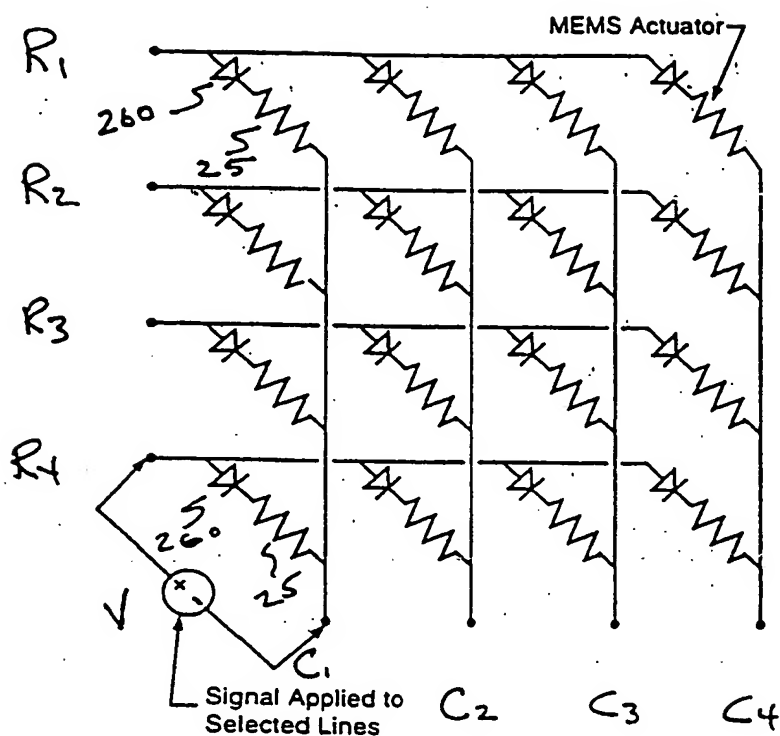


FIGURE 13

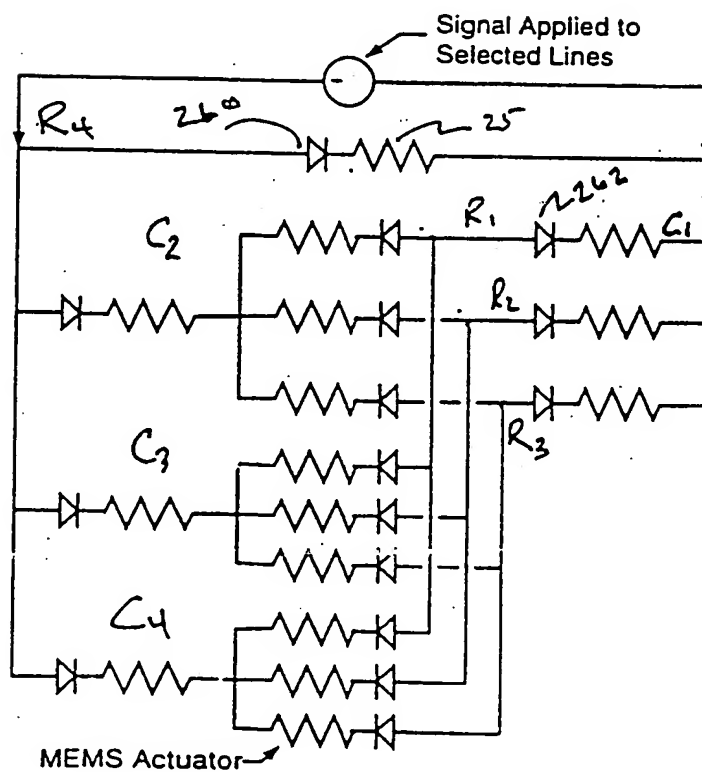


FIGURE 14

INTERNATIONAL SEARCH REPORT

Internat. application No.
PCT/US99/24591

A. CLASSIFICATION OF SUBJECT MATTER

IPC(6) : G02B 6/26

US CL : 385/16, 17, 18

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

U.S. : 385/16, 17, 18, 19, 20

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched
None

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

BRS. US patent data base. SEarch terms: optical switch, fluid, moving, actuator.

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	US 5,699,462 A (FOUQUET ET AL) 16 DECEMBER 1997 (16/12/97), see entire document.	1-66
A	US 5,367,584 A (GHEZZO ET AL) 22 NOVEMBER 1994 (22/11/94), see entire document.	1-66

☐ Further documents are listed in the continuation of Part C. ☐ See patent family annex.

* Special categories of cited documents:	
"A" document defining the general state of the art which is not considered to be of particular relevance	"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention
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"P" document published prior to the international filing date but later than the priority date claimed	

Date of the actual completion of the international search

13 JANUARY 2000

Date of mailing of the international search report

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